Vishay Siliconix

# Common Drain Dual N-Channel 30 V (S1-S2) MOSFET

# PowerPAK® 1212-8SCD S1 8 S2 6 S2 7 S1 8 S2 G1 S2 G1 S2 G1 S2 G1 S3 D1 G2 G2

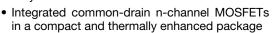
Top View

**Bottom View** 

PRODUCT SUMMARY	
V <sub>S1S2</sub> (V)	30
$R_{S1S2(on)}$ max. ( $\Omega$ ) at $V_{GS} = 10 \text{ V}$	0.00450
$R_{S1S2(on)}$ max. ( $\Omega$ ) at $V_{GS} = 4.5 \text{ V}$	0.00695
Q <sub>g</sub> typ. (nC) <sup>g</sup>	14
I <sub>S1S2</sub> (A) <sup>a</sup>	101
Configuration	Common drain

#### **FEATURES**

- TrenchFET® Gen IV power MOSFET
- Very low source-to-source on resistance

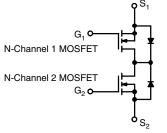




- 100 % R<sub>g</sub> and UIS tested
- · Optimizes circuit layout for bi-directional current flow
- Material categorization: for definitions of compliance please see <a href="https://www.vishav.com/doc?99912"><u>www.vishav.com/doc?99912</u></a>

#### **APPLICATIONS**

- · Battery protection switch
- Bi-directional switch
- Load switch



ORDERING INFORMATION	
Package	PowerPAK 1212-8SCD
Lead (Pb)-free and halogen-free	SiSF06DN-T1-GE3

<b>ABSOLUTE MAXIMUM RATINO</b>	<b>GS</b> ( $T_A = 25  ^{\circ}\text{C}$ , $\iota$	ınless otherwi	ise noted)	
PARAMETER		SYMBOL	LIMIT	UNIT
Drain-source voltage		V <sub>S1S2</sub>	30	V
Gate-source voltage		$V_{GS}$	+20 / -16	
	T <sub>C</sub> = 25 °C		101	
Oti	T <sub>C</sub> = 70 °C	1 .	81	
Continuous drain current (T <sub>J</sub> = 150 °C)	T <sub>A</sub> = 25 °C	I <sub>S1S2</sub>	28 <sup>b, c</sup>	Α
	T <sub>A</sub> = 70 °C	1	22 <sup>b, c</sup>	
Pulsed drain current (t = 100 μs)		I <sub>S1S2M</sub>	190	
	T <sub>C</sub> = 25 °C		69.4	
Maximum power dissipation	T <sub>C</sub> = 70 °C	1 5 [	44.4	147
	T <sub>A</sub> = 25 °C	P <sub>D</sub>	5.2 b, c	W
	T <sub>A</sub> = 70 °C	1	3.3 b, c	
Operating junction and storage temperature range		T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C
Soldering recommendations (peak temperature) c			260	

THERMAL RESISTANCE RATI	NGS				
PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT
Maximum junction-to-ambient <sup>b</sup>	t ≤ 10 s	R <sub>thJA</sub>	19	24	°C/W
Maximum junction-to-case (drain)	Steady state	R <sub>thJC</sub>	1.4	1.8	C/VV

#### Notes

- a.  $T_C = 25 \,^{\circ}C$
- b. Surface mounted on 1" x 1" FR4 board
- c. t = 10 s
- d. See solder profile (www.vishay.com/doc?73257). The PowerPAK 1212-8SCD is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection
- e. Rework conditions: manual soldering with a soldering iron is not recommended for leadless components
- f. Maximum under steady state conditions is 63 °C/W
- g. Single MOSFET



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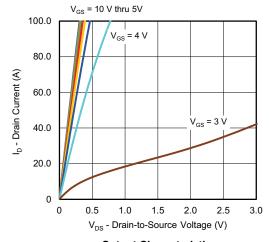
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static			•			
Drain-source breakdown voltage	$V_{DS}$	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	30	-	-	V
Gate-source threshold voltage	V <sub>GS(th)</sub>	$V_{S1S2} = V_{GS}, I_D = 250 \mu A$	1	-	2.3	V
Gate-source leakage	I <sub>GSS</sub>	$V_{S1S2} = 0 \text{ V}, V_{GS} = +20 \text{ V} / -16 \text{ V}$	-	-	± 100	nA
Zana mata walta na alumin awamant		V <sub>S1S2</sub> = 30 V, V <sub>GS</sub> = 0 V	-	-	1	μΑ
Zero gate voltage drain current	I <sub>DSS</sub>	V <sub>S1S2</sub> = 30 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 70 °C	-	-	15	
On-state drain current <sup>a</sup>	I <sub>S1S2(on)</sub>	V <sub>S1S2</sub> ≥ 10 V, V <sub>GS</sub> = 10 V	20	-	-	Α
Duain an una an atata mariatana a	_	V <sub>GS</sub> = 10 V, I <sub>S1S2</sub> = 7 A			0.00450	0
Drain-source on-state resistance <sup>a</sup>	R <sub>S1S2(on)</sub>	V <sub>GS</sub> = 4.5 V, I <sub>S1S2</sub> = 5 A	-	0.00536	0.00695	Ω
Forward transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>S1S2</sub> = 10 V, I <sub>S1S2</sub> = 35 A	-	115	-	S
Dynamic <sup>b, c</sup>						
Input capacitance	C <sub>iss</sub>		-	2050	-	
Output capacitance	Coss	$V_{DS} = 15 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	-	855	-	pF
Reverse transfer capacitance	C <sub>rss</sub>		-	40	-	1
		$V_{DS} = 15 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 5 \text{ A}$	-	30	45	
Total gate charge	$Q_g$		-	14	21	0
Gate-source charge	$Q_{gs}$	$V_{DS} = 10 \text{ V}, V_{GS} = 4.5 \text{ V}, I_D = 5 \text{ A}$	-	6.1	-	nC
Gate-drain charge	$Q_{gd}$		-	2.8	-	
Gate resistance	$R_g$	f = 1 MHz	0.2	1.1	2.2	Ω
Turn-on delay time	t <sub>d(on)</sub>		-	18	36	
Rise time	t <sub>r</sub>	$V_{DD} = 15 \text{ V}, R_L = 3 \Omega, I_{S1S2} \cong 5 \text{ A},$	-	10	20	
Turn-off delay time	t <sub>d(off)</sub>	$V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$	-	35	70	1
Fall time	t <sub>f</sub>		-	10	20	
Turn-on delay time	t <sub>d(on)</sub>		-	30	60	ns
Rise time	t <sub>r</sub>	$V_{DD} = 15 \text{ V}, R_L = 3 \Omega, I_D \cong 5 \text{ A},$	-	60	120	
Turn-off delay time	t <sub>d(off)</sub>	$V_{GEN} = 4.5 \text{ V}, R_g = 1 \Omega$	-	35	70	
Fall time	t <sub>f</sub>		-	20	40	
Drain-Source Body Diode Characteristi	cs <sup>c</sup>					
Continuous source-drain diode current	I <sub>S1S2</sub>	T <sub>C</sub> = 25 °C	-	-	60	^
Pulse diode forward current	I <sub>S1S2M</sub>		-	-	190	Α
Body diode reverse recovery time	t <sub>rr</sub>		-	34	51	ns
Body diode reverse recovery charge	Q <sub>rr</sub>	$I_F = 5 \text{ A, di/dt} = 100 \text{ A/µs,}$	-	25	50	nC
Reverse recovery fall time	t <sub>a</sub>	T <sub>J</sub> = 25 °C	-	17	-	
Reverse recovery rise time	t <sub>b</sub>		-	17	-	ns

#### Notes

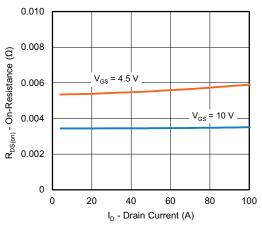
- a. Pulse test; pulse width  $\leq 300~\mu s,$  duty cycle  $\leq 2~\%$
- b. Guaranteed by design, not subject to production testing
- c. On single MOSFET

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

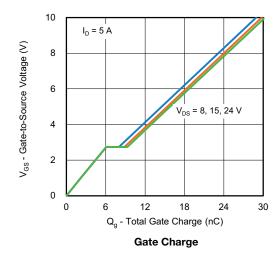




#### **Output Characteristics**



On-Resistance vs. Source Current and Gate Voltage



T<sub>c</sub> = -55 °C

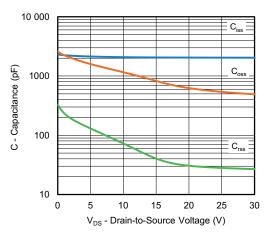
T<sub>c</sub> = -55 °C

T<sub>c</sub> = 125 °C

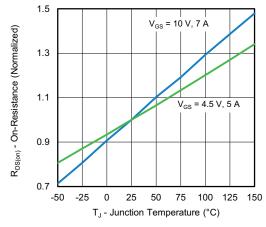
T<sub>c</sub> = 125 °C

T<sub>c</sub> = 125 °C

**Transfer Characteristics** 

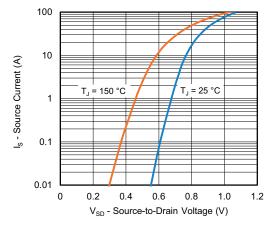


Capacitance

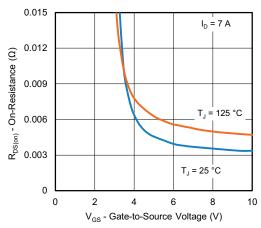


On-Resistance vs. Junction Temperature

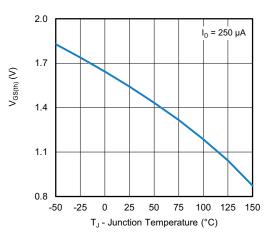




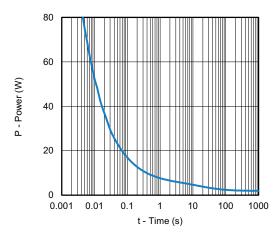
Source-Drain Diode Forward Voltage



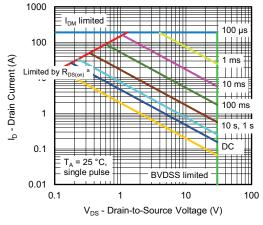
On-Resistance vs. Gate-to-Source Voltage



**Threshold Voltage** 



Single Pulse Power, Junction-to-Ambient

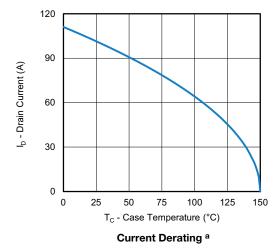


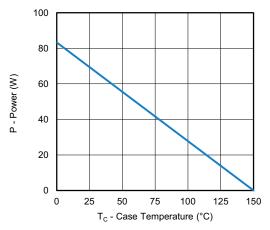
Safe Operating Area, Junction-to-Ambient

#### Notes

a.  $V_{GS}$  > minimum  $V_{GS}$  at which  $R_{DS(on)}$  is specified





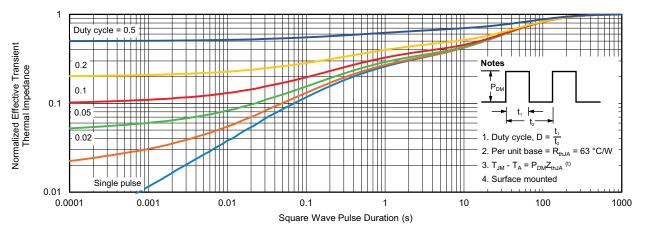


Power, Junction-to-Case

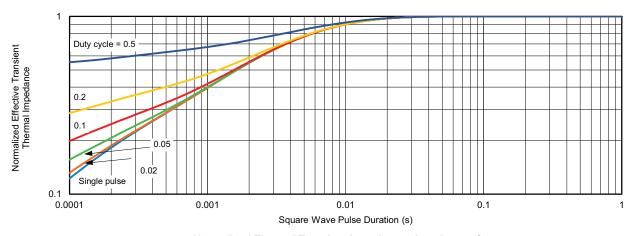
#### Notes

a. The power dissipation P<sub>D</sub> is based on T<sub>J</sub> max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit





Normalized Thermal Transient Impedance, Junction-to-Ambient

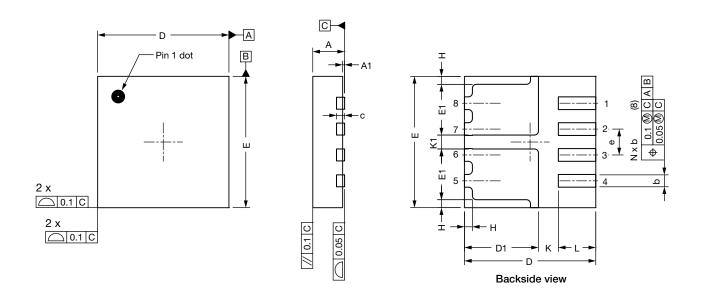


Normalized Thermal Transient Impedance, Junction-to-Case

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# PowerPAK® 1212-8S CD with Flip Chip

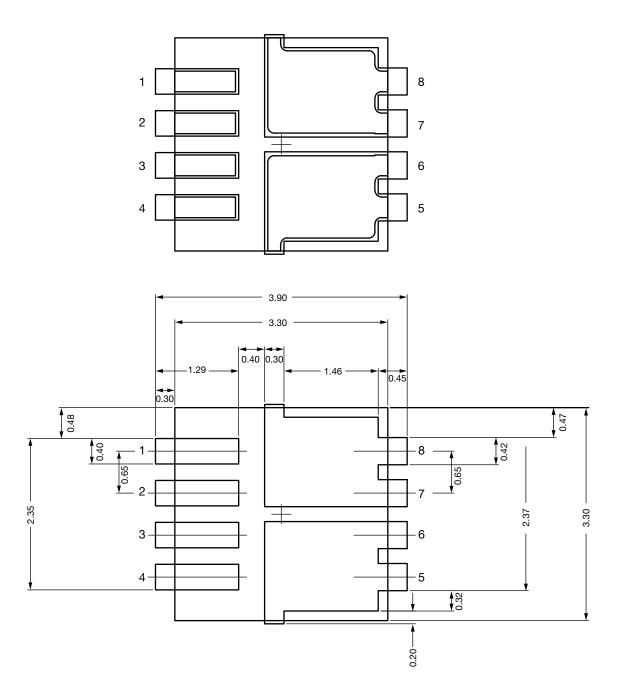


DIM.	MILLIMETERS			INCHES			
	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.	
Α	0.70	0.75	0.80	0.027	0.029	0.031	
A1	0	0.02	0.05	0	0.001	0.002	
b	0.27	0.32	0.37	0.011	0.013	0.015	
С	-	0.20 ref.	-	-	0.008 ref.	-	
D	3.20	3.30	3.40	0.126	0.130	0.134	
D1	1.76	1.86	1.96	0.069	0.073	0.077	
E	3.20	3.30	3.40	0.126	0.130	0.134	
E1	1.18	1.28	1.38	0.046	0.050	0.054	
е	0.60	0.65	0.70	0.024	0.026	0.028	
K		0.50 typ.			0.020 typ.		
K1	0.35 typ.		0.014 typ.				
Н	0.10	0.20	0.30	0.006	0.008	0.010	
L	0.84	0.94	1.04	0.033	0.037	0.041	

DWG: 6061



# Recommended Land Pattern PowerPAK® 1212-8S CD





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